Vishay Semiconductors

High Speed Infrared Emitting Diodes, 890 nm, Surface Emitter Technology



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DESCRIPTION

As part of the SurfLightTM portfolio, the VSMY2893 series are infrared, 890 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

FEATURES

- Package type: surface-mount
- · Package form: GW, RGW, side view
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55
- AEC-Q101 gualified
- Peak wavelength: $\lambda_p = 890 \text{ nm}$
- Angle of half intensity: $\varphi = \pm 28^{\circ}$
- · Suitable for high pulse current operation
- · Terminal configurations: gullwing or reverse gullwing
- Package matches with detector VEMD2503X01 series

Floor life: 4 weeks, MSL 2a, according to J-STD-020

 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Automotive sensors
- Optical switch
- · Emitter source for proximity sensors
- IR illumination

PRODUCT SUMMARY					
COMPONENT	I_e (mW/sr) at I_F = 100 mA	φ (°)	λ _P (nm)	t _r (ns)	
VSMY2893RGX01	50	± 28	890	15	
VSMY2893GX01	50	± 28	890	15	
VSMY2893SLX01	50	± 28	890	15	

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VSMY2893RGX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing		
VSMY2893GX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing		
VSMY2893SLX01	Tape and reel	MOQ: 6000 pcs, 3000 pcs/reel	Side view		

Note

• MOQ: minimum order quantity





RoHS COMPLIANT

HALOGEN

FREE **GREEN**

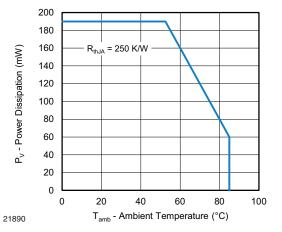
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ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Forward current		l _F	100	mA	
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	200	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1	A	
Power dissipation		Pv	190	mW	
Junction temperature		Тj	100	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-40 to +100	°C	
Soldering temperature	According to Fig. 9, J-STD-020	T _{sd}	260	°C	
Thermal resistance junction-to-ambient	JESD51	R _{thJA}	250	K/W	





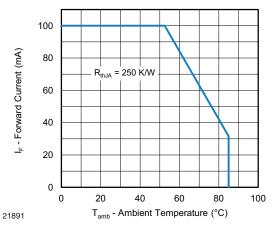


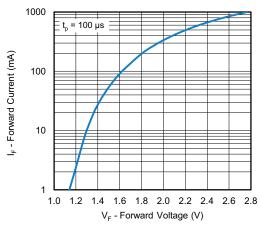
Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 100 mA, t _p = 20 ms	V _F	-	1.6	1.9	V
	I _F = 1 A, t _p = 100 μs	V _F	-	2.8	-	V
Temperature coefficient of V _F	I _F = 100 mA	TK _{VF}	-	-2.0	-	mV/K
Reverse current		I _R	Not designed for reverse operation		μA	
Junction capacitance	$V_R = 0 V$, f = 1 MHz, E = 0 mW/cm ²	CJ	-	60	-	pF
Radiant intensity	I _F = 100 mA, t _p = 20 ms	le	27	50	75	mW/sr
	I _F = 1 A, t _p = 100 μs	l _e	-	350	-	mW/sr
Radiant power	I _F = 100 mA, t _p = 20 ms	фе	-	55	-	mW
Temperature coefficient of radiant power	I _F = 100 mA	TKφ _e	-	-0.15	-	%/K
Angle of half intensity		φ	-	± 28	-	٥
Peak wavelength	I _F = 100 mA	λ _p	870	890	910	nm
Spectral bandwidth	I _F = 100 mA	Δλ	-	35	-	nm
Temperature coefficient of λ_p	I _F = 100 mA	ΤΚλ _p	-	0.3	-	nm/K
Rise time	I _F = 100 mA, 10 % to 90 %	t _r	-	15	-	ns
Fall time	I _F = 100 mA, 10 % to 90 %	t _f	-	15	-	ns

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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



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Fig. 3 - Forward Current vs. Forward Voltage

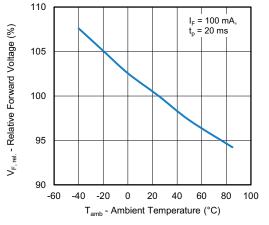


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

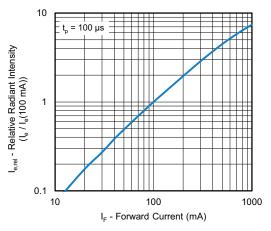


Fig. 5 - Relative Radiant Intensity vs. Forward Current

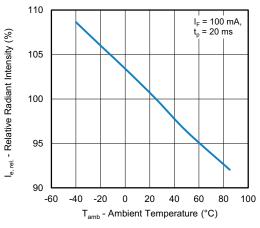


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

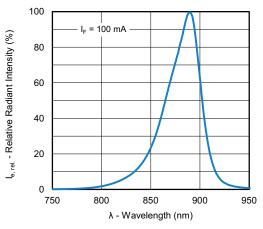
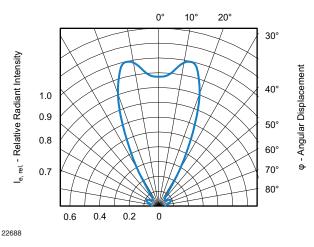
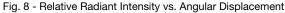


Fig. 7 - Relative Radiant Intensity vs. Wavelength





Rev. 1.0, 17-Jul-2019

3 For technical questions, contact: <u>emittertechsupport@vishay.com</u> Document Number: 80145

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SOLDER PROFILE

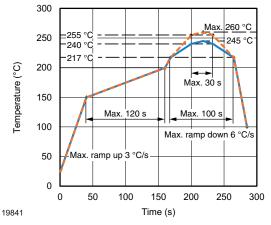


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

Conditions: $T_{amb} < 30\ ^\circ C,\ RH < 60\ \%$

Moisture sensitivity level 2a, according to J-STD-020.

DRYING

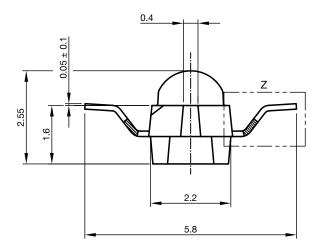
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

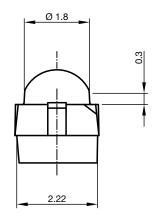


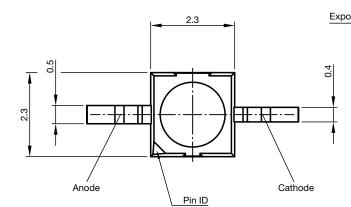
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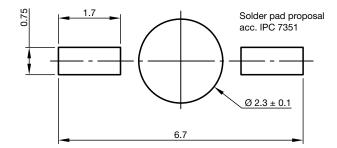
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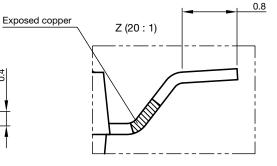
PACKAGE DIMENSIONS in millimeters: VSMY2893RGX01







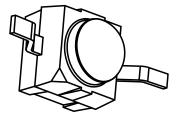






according to DIN specifications

Not indicated tolerances ± 0.2



Drawing-No.: 6.544-5409.03-4 Issue: 3; 02.10.15

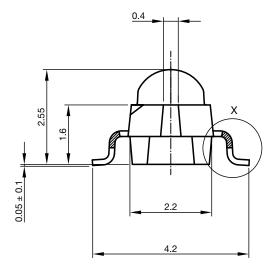
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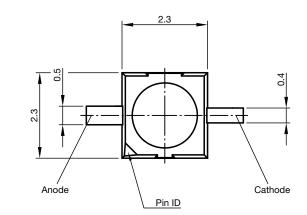


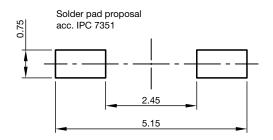
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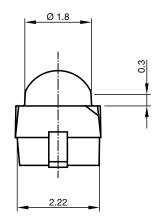
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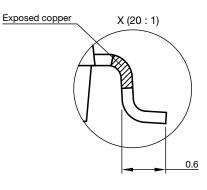






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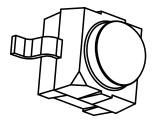






Technical drawings according to DIN specifications

Not indicated tolerances ± 0.2



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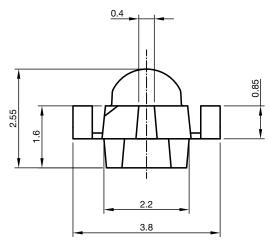
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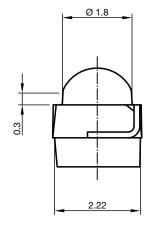


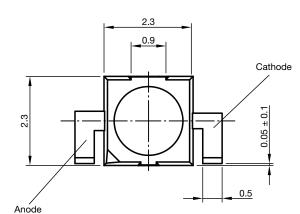
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PACKAGE DIMENSIONS in millimeters: VSMY2893SLX01





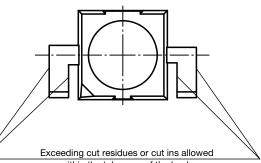


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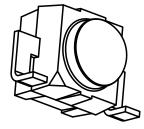
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center of pick and place area Technical drawings according to DIN specifications

Not indicated tolerances ± 0.2



within the tolerance of the leads



Drawing-No.: 6.544-5410.03-4 Issue: 3; 02.10.15

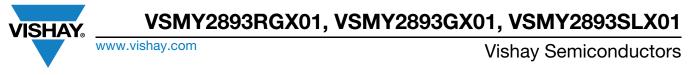
4.2

Solder pad proposal acc. IPC 7351

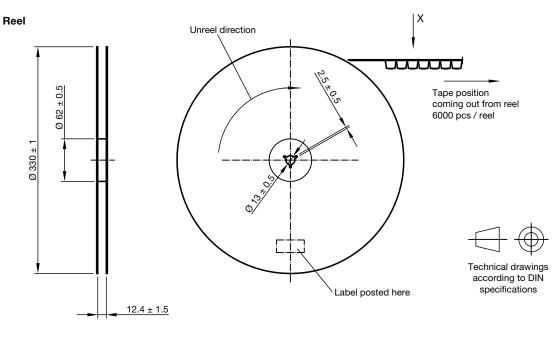
0.9

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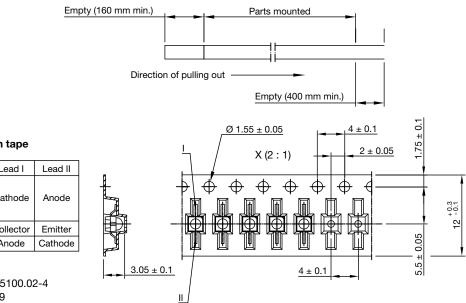
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TAPING AND REEL DIMENSIONS in millimeters: VSMY2893RGX01



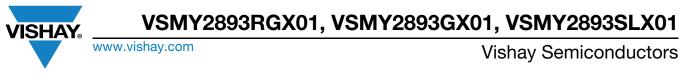
Leader and trailer tape



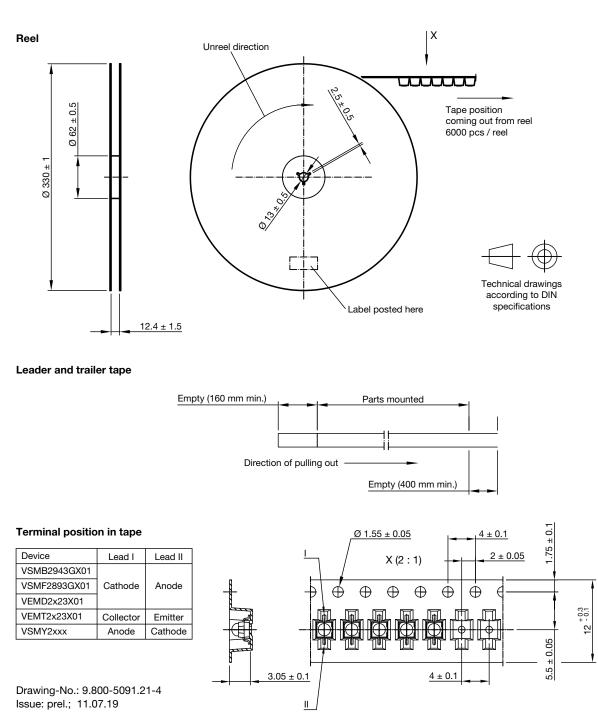
Terminal position in tape

Device	Lead I	Lead II	
VSMB2943RGX01			
VSMF2893RGX01	Cathode	Anode	
VEMD2x03X01			
VEMT2x03X01	Collector	Emitter	
VSMY2xxx	Anode	Cathode	

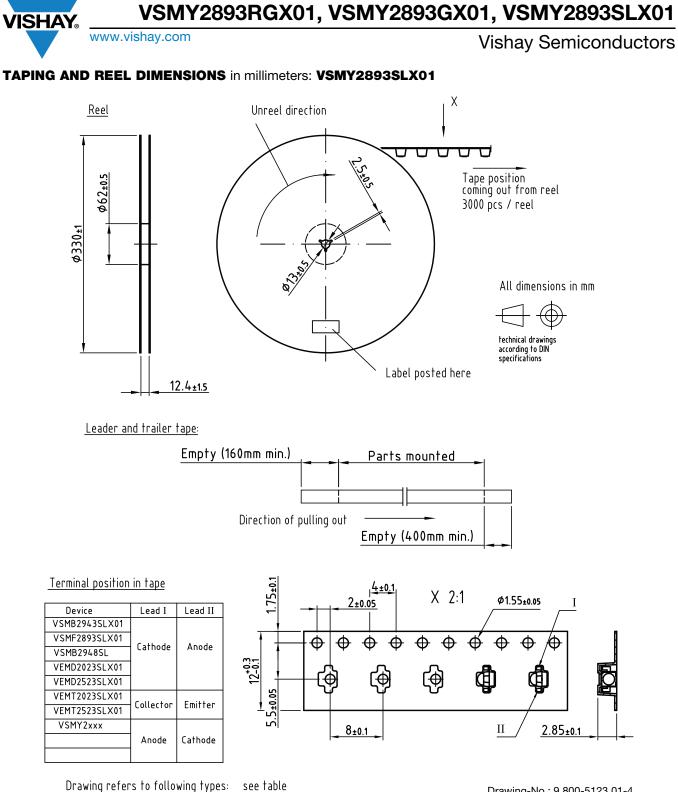
Drawing-No.: 9.800-5100.02-4 Issue: prel.; 11.07.19



TAPING AND REEL DIMENSIONS in millimeters: VSMY2893GX01



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Drawing-No.: 9.800-5123.01-4 Issue: preliminary, 11.07.19

Reel dimensions and tape

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